

N-Channel PowerTrench[®] SyncFETTM 25 V, 130 A, 1.2 m Ω

Features

- Max $r_{DS(on)}$ = 1.2 m Ω at V_{GS} = 10 V, I_D = 35 A
- Max $r_{DS(on)}$ = 1.65 m Ω at V_{GS} = 4.5 V, I_D = 31 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

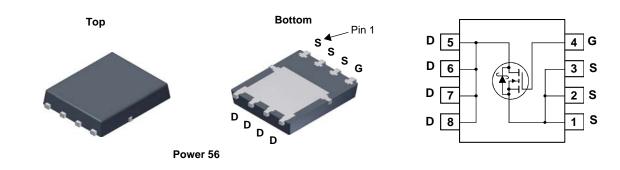


General Description

The FDMS7556S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for Synchronous Buck Converters
- Notebook
- Server
- Telecom
- High Efficiency DC-DC Switch Mode Power Supplies



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			25	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25 °C		130		
,	-Continuous (Silicon limited)	T _C = 25 °C		222	^	
D	-Continuous	T _A = 25 °C	(Note 1a)	35	Α	
	-Pulsed			200		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	312	mJ	
D	Power Dissipation	T _C = 25 °C		96	w	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature R	ange		-55 to +150	°C	

R_{\thetaJC}	Thermal Resistance, Junction to Case	1.3	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/VV	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7556S	FDMS7556S	Power 56	13 "	12 mm	3000 units

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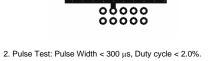
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	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	25			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		22		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 20 V, V_{GS} = 0 V$			500	μΑ
GSS	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	1.2	1.6	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.l}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		-5		mV/°C
		V _{GS} = 10 V, I _D = 35 A		0.95	1.2	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 31 \text{ A}$		1.3	1.65	mΩ
- (-)		V _{GS} = 10 V, I _D = 35 A, T _J = 125 °C		1.2	1.6	
9fs	Forward Transconductance	V _{DS} = 5 V, I _D = 35 A		212		S
C _{iss}	Input Capacitance	V _{DS} = 13 V, V _{GS} = 0 V,		6740	8965	рF
				1010	2500	~ -
C _{oss}	Output Capacitance	_f = 1 MHz		1940	2580	pF
	Output Capacitance Reverse Transfer Capacitance Gate Resistance			314 0.6	475 1.3	ρF pF Ω
C _{oss} C _{rss} R _g Switchinç	Reverse Transfer Capacitance Gate Resistance Characteristics			314	475	pF
C _{oss} C _{rss} R _g Switching	Reverse Transfer Capacitance Gate Resistance	- f = 1 MHz		314 0.6	475 1.3	pF Ω
C _{oss} C _{rss} Rg Switching t _{d(on)}	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time			314 0.6 20	475 1.3 36	pF Ω ns
C _{oss} C _{rss} Rg Switching t _{d(on)} t _r t _{d(off)}	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time	f = 1 MHz V _{DD} = 13 V, I _D = 35 A,		314 0.6 20 9	475 1.3 36 18	pF Ω ns
C _{oss} C _{rss} Rg Switching t _{d(on)} t _r t _{d(off)} t _f	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	f = 1 MHz V _{DD} = 13 V, I _D = 35 A,		314 0.6 20 9 48	475 1.3 36 18 77	pF Ω ns ns ns
C _{oss} C _{rss} R g Switching t _{d(on)} t _r t _{d(off)} t _f Q _g	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, I_D = 35 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V}$		314 0.6 20 9 48 5.3	475 1.3 36 18 77 11	pF Ω ns ns ns ns
C _{oss} C _{rss} R g Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	f = 1 MHz V _{DD} = 13 V, I _D = 35 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		314 0.6 20 9 48 5.3 95	475 1.3 36 18 77 11 133	pF Ω ns ns ns ns nC
C _{oss} C _{rss} R g Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs}	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, I_D = 35 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V}$		314 0.6 20 9 48 5.3 95 43	475 1.3 36 18 77 11 133	pF Ω ns ns ns nC nC
C _{oss} C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge	$f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, I_D = 35 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 13 \text{ V}$		314 0.6 20 9 48 5.3 95 43 18.6	475 1.3 36 18 77 11 133	pF Ω ns ns ns nC nC nC
C _{oss} C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd} Drain-Sou	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge			314 0.6 20 9 48 5.3 95 43 18.6	475 1.3 36 18 77 11 133	pF Ω ns ns ns nC nC nC nC
C _{oss} C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge	$f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, I_D = 35 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{DD} = 13 \text{ V}$ $I_D = 35 \text{ A}$		314 0.6 20 9 48 5.3 95 43 18.6 8.8	475 1.3 36 18 77 11 133 60	pF Ω ns ns ns nC nC nC
C _{oss} C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd} Drain-Sou	Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge			314 0.6 20 9 48 5.3 95 43 18.6 8.8	475 1.3 36 18 77 11 133 60 0.7	pF Ω ns ns ns nC nC nC nC

1 in² pad of 2 oz copper.



b. 125 °C/W when mounted on a minimum pad of 2 oz copper.



3. E_{AS} of 312 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 25 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 38 A.

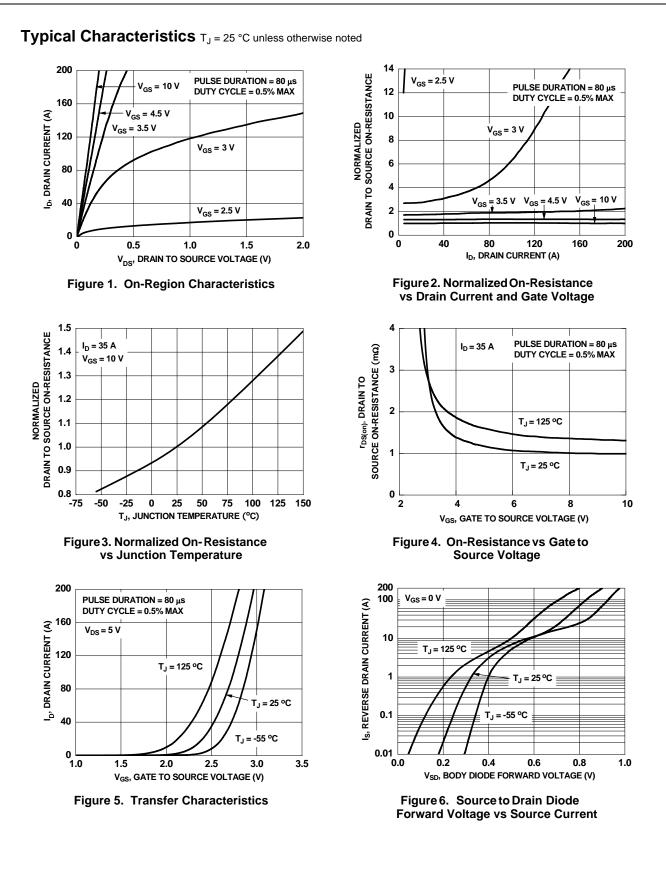
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

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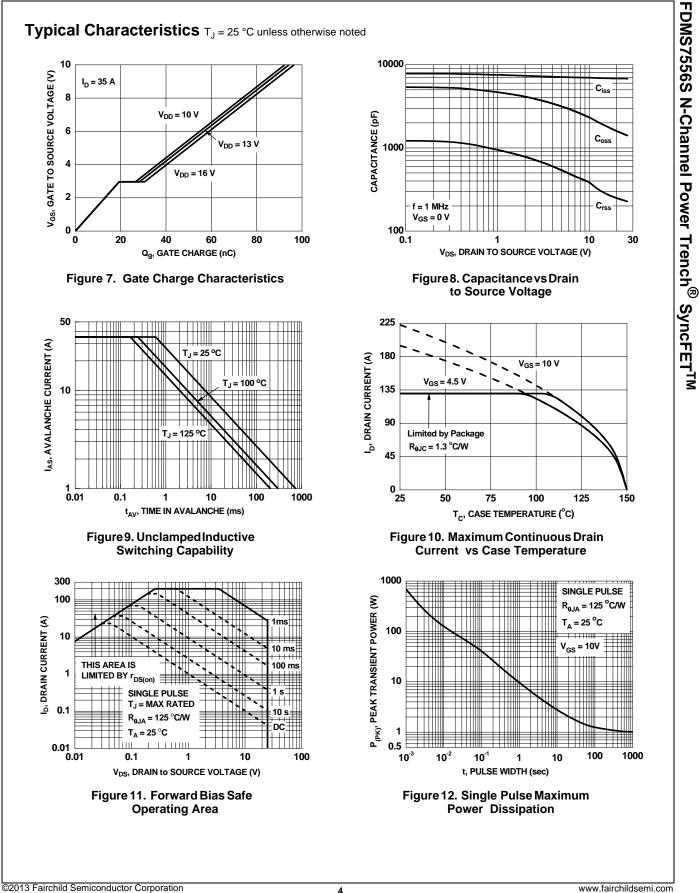
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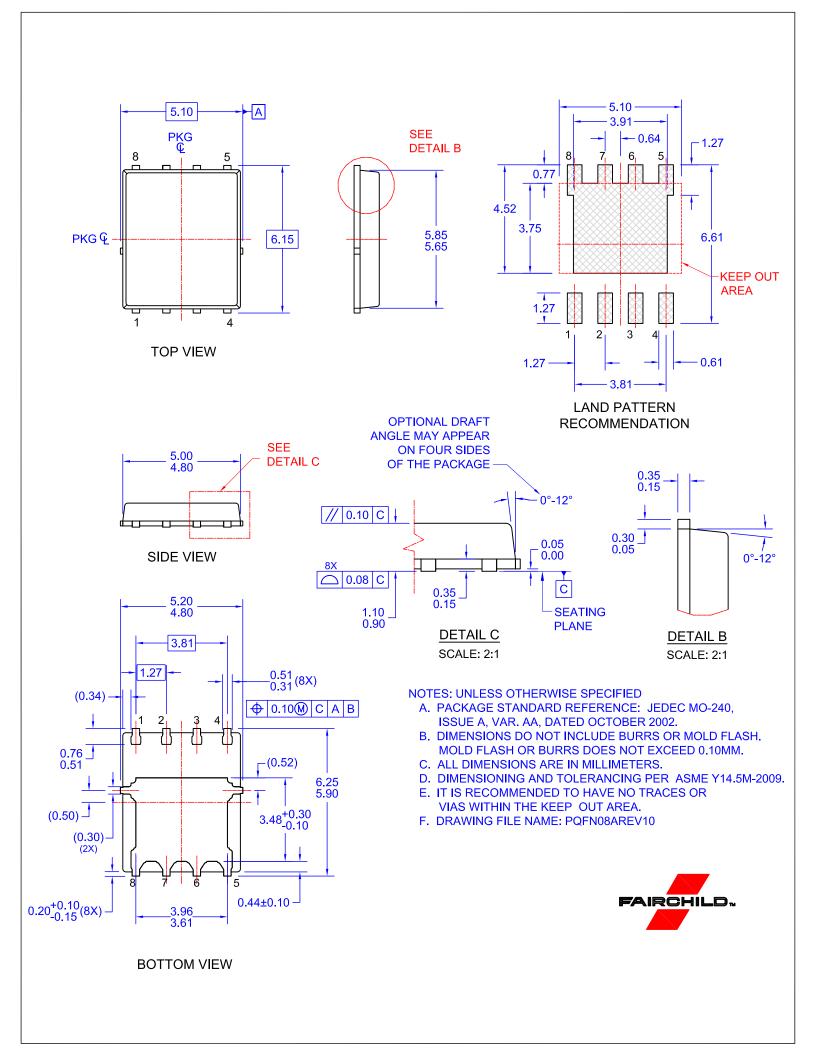
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